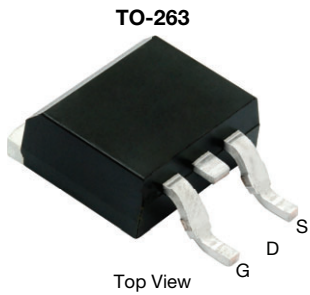


Automotive N-Channel 30 V (D-S) 175 °C MOSFET



FEATURES

- TrenchFET® power MOSFET
- Package with low thermal resistance
- 100 % R_g and UIS tested
- AEC-Q101 qualified
- Material categorization:
for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE



PRODUCT SUMMARY	
V _{DS} (V)	30
R _{DS(on)} (Ω) at V _{GS} = 10 V	0.00135
R _{DS(on)} (Ω) at V _{GS} = 4.5 V	0.00175
I _D (A)	120
Configuration	Single
Package	TO-263

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	30	V
Gate-source voltage		V _{GS}	± 20	
Continuous drain current ^a	T _C = 25 °C	I _D	120	A
	T _C = 125 °C		120	
Continuous source current (diode conduction) ^a		I _S	120	
Pulsed drain current ^b		I _{DM}	360	
Single pulse avalanche current	L = 0.1 mH	I _{AS}	72	
Single pulse avalanche energy		E _{AS}	259	
Maximum power dissipation ^b	T _C = 25 °C	P _D	375	W
	T _C = 125 °C		125	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount ^c	R _{thJA}	40	°C/W
Junction-to-case (drain)		R _{thJC}	0.4	

Notes

- Package limited
- Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %
- When mounted on 1" square PCB (FR4 material)



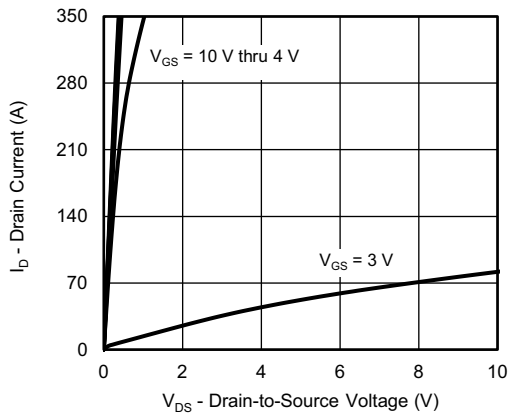
SPECIFICATIONS ($T_C = 25\text{ }^\circ\text{C}$, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0\text{ V}$, $I_D = 250\text{ }\mu\text{A}$	30	-	-	V
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250\text{ }\mu\text{A}$	1.5	2.0	2.5	
Gate-source leakage	I_{GSS}	$V_{DS} = 0\text{ V}$, $V_{GS} = \pm 20\text{ V}$	-	-	± 100	nA
Zero gate voltage drain current	I_{DSS}	$V_{GS} = 0\text{ V}$, $V_{DS} = 30\text{ V}$	-	-	1	μA
		$V_{GS} = 0\text{ V}$, $V_{DS} = 30\text{ V}$, $T_J = 125\text{ }^\circ\text{C}$	-	-	50	
		$V_{GS} = 0\text{ V}$, $V_{DS} = 30\text{ V}$, $T_J = 175\text{ }^\circ\text{C}$	-	-	800	μA
On-state drain current ^a	$I_{D(on)}$	$V_{GS} = 10\text{ V}$, $V_{DS} \geq 5\text{ V}$	100	-	-	A
Drain-source on-state resistance ^a	$R_{DS(on)}$	$V_{GS} = 10\text{ V}$, $I_D = 40\text{ A}$	-	0.00110	0.00135	Ω
		$V_{GS} = 10\text{ V}$, $I_D = 40\text{ A}$, $T_J = 125\text{ }^\circ\text{C}$	-	-	0.00191	
		$V_{GS} = 10\text{ V}$, $I_D = 40\text{ A}$, $T_J = 175\text{ }^\circ\text{C}$	-	-	0.00220	
		$V_{GS} = 4.5\text{ V}$, $I_D = 35\text{ A}$	-	0.00143	0.00175	Ω
Forward transconductance ^b	g_{fs}	$V_{DS} = 15\text{ V}$, $I_D = 40\text{ A}$	-	233	-	S
Dynamic ^b						
Input capacitance	C_{iss}	$V_{GS} = 0\text{ V}$, $V_{DS} = 15\text{ V}$, $f = 1\text{ MHz}$	-	20 090	28 000	μF
Output capacitance	C_{oss}		-	7000	9500	
Reverse transfer capacitance	C_{rss}		-	540	750	
Total gate charge ^c	Q_g	$V_{GS} = 10\text{ V}$, $V_{DS} = 15\text{ V}$, $I_D = 50\text{ A}$	-	295	450	nC
Gate-source charge ^c	Q_{gs}		-	59	-	
Gate-drain charge ^c	Q_{gd}		-	59	-	
Gate resistance	R_g	$f = 1\text{ MHz}$	0.5	1.11	1.7	Ω
Turn-on delay time ^c	$t_{d(on)}$	$V_{DD} = 15\text{ V}$, $R_L = 0.2\text{ }\Omega$ $I_D \cong 50\text{ A}$, $V_{GEN} = 10\text{ V}$, $R_g = 1\text{ }\Omega$	-	30	45	ns
Rise time ^c	t_r		-	240	360	
Turn-off delay time ^c	$t_{d(off)}$		-	98	150	
Fall time ^c	t_f		-	44	70	
Source-Drain Diode Ratings and Characteristics ^b						
Pulsed current ^a	I_{SM}		-	-	360	A
Forward voltage	V_{SD}	$I_F = 60\text{ A}$, $V_{GS} = 0\text{ V}$	-	0.8	1.5	V
Body diode reverse recovery time	t_{rr}	$I_F = 35\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$	-	96	195	ns
Body diode reverse recovery charge	Q_{rr}		-	185	370	nC
Reverse recovery fall time	t_a		-	48	-	ns
Reverse recovery rise time	t_b		-	48	-	
Body diode peak reverse recovery current	$I_{RM(REC)}$			-	-3.4	-

Notes

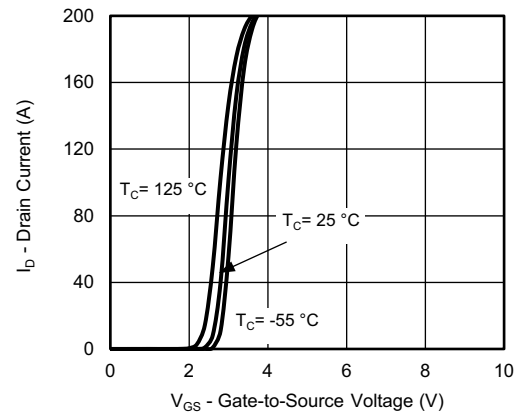
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
b. Guaranteed by design, not subject to production testing
c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

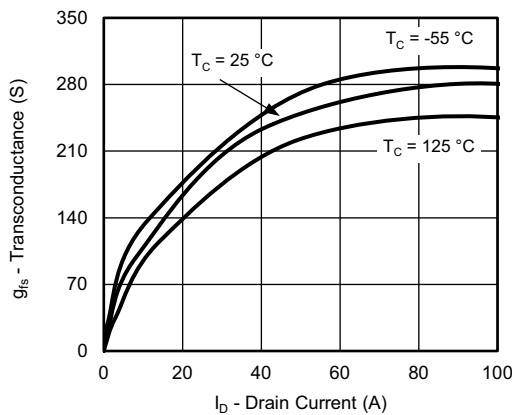
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)



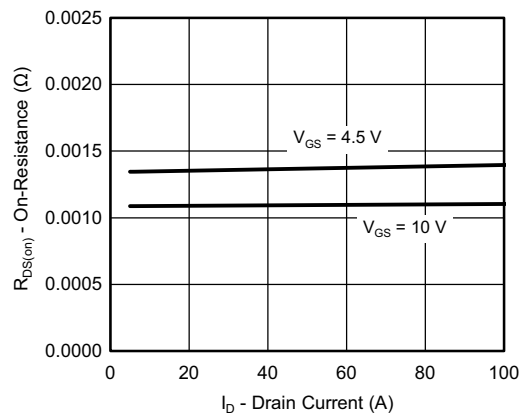
Output Characteristics



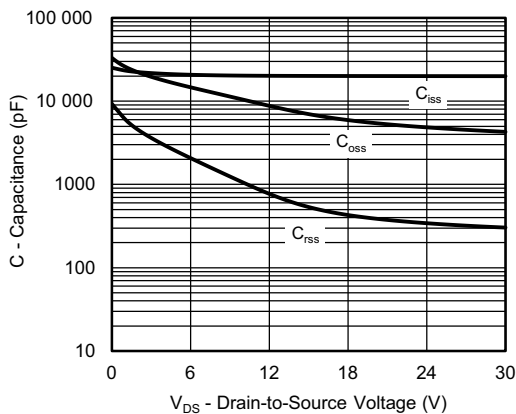
Transfer Characteristics



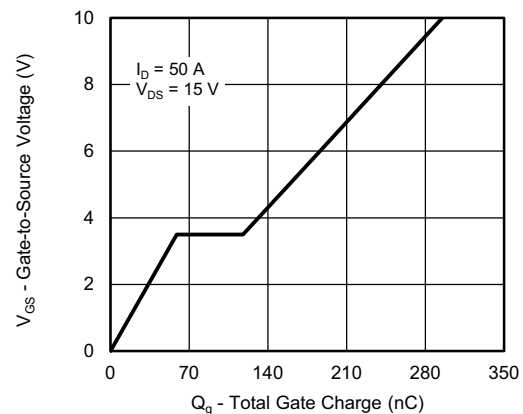
Transconductance



On-Resistance vs. Drain Current



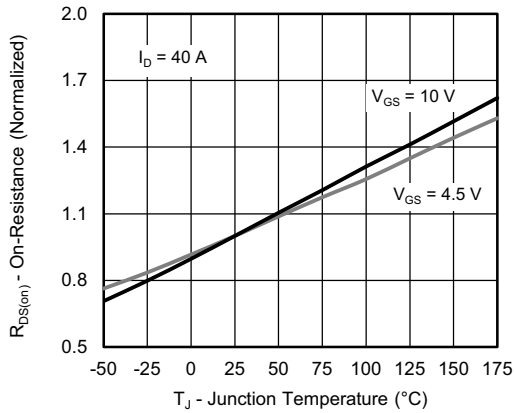
Capacitance



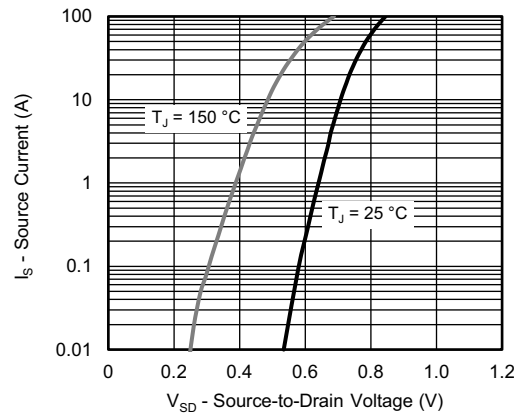
Gate Charge



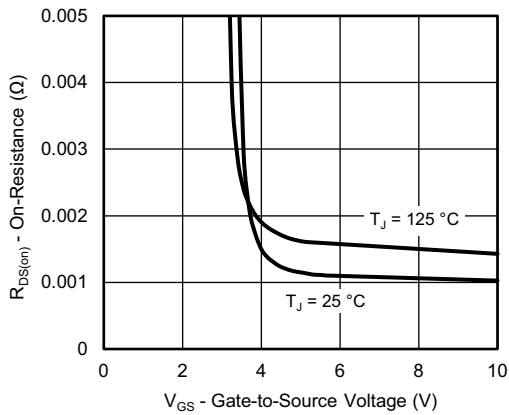
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)



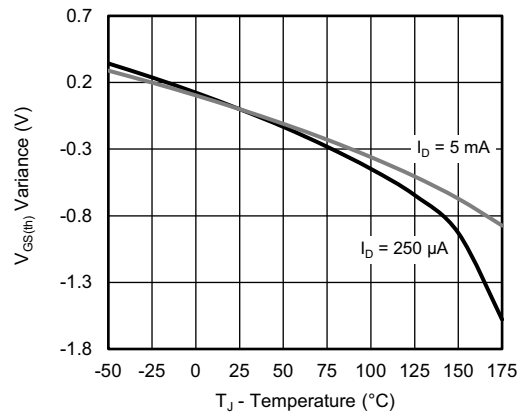
On-Resistance vs. Junction Temperature



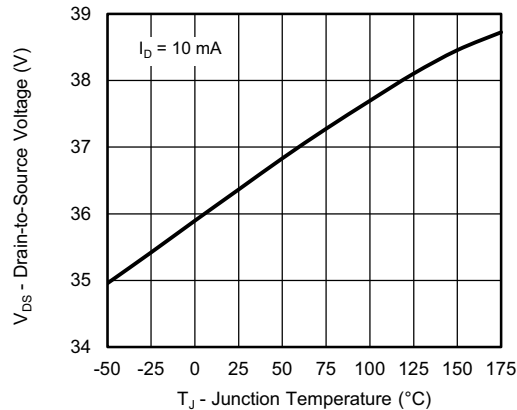
Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



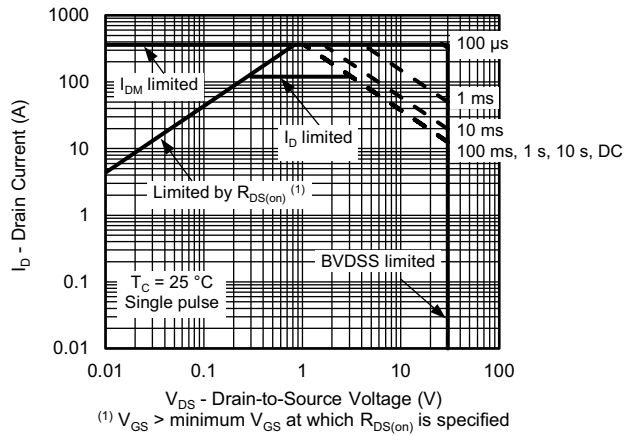
Threshold Voltage



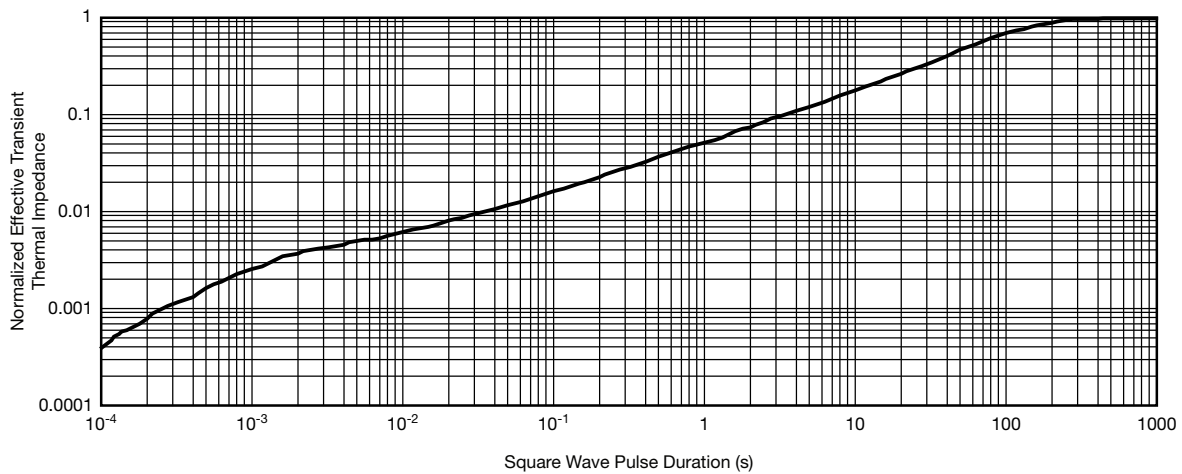
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)



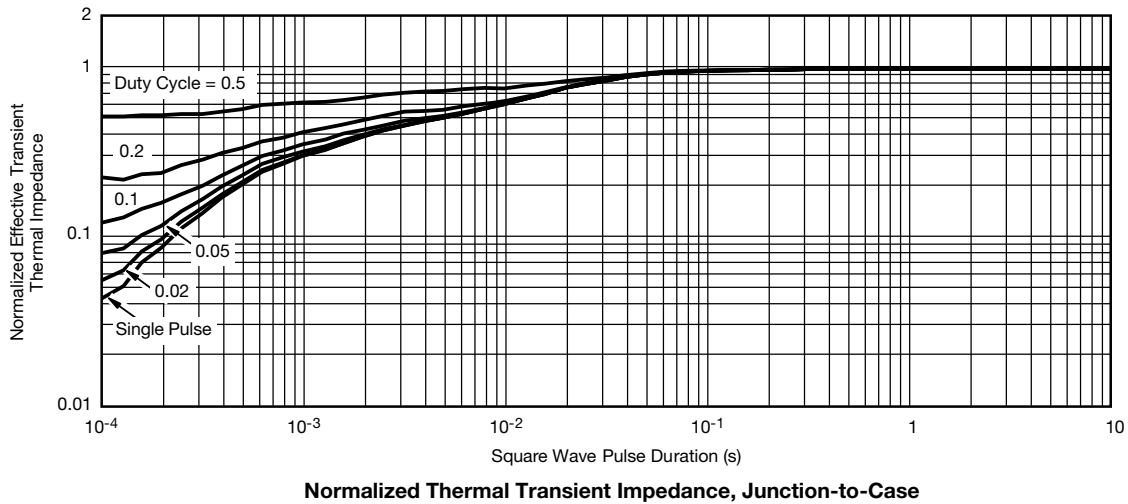
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)



Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)
 are given for general guidelines only to enable the user to get a “ball park” indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
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